# Presettable Divide-By-N Counter

The MC14018B contains five Johnson counter stages which are asynchronously presettable and resettable. The counters are synchronous, and increment on the positive going edge of the clock.

Presetting is accomplished by a logic 1 on the preset enable input. Data on the Jam inputs will then be transferred to their respective  $\overline{Q}$  outputs (inverted). A logic 1 on the reset input will cause all  $\overline{Q}$  outputs to go to a logic 1 state.

Division by any number from 2 to 10 can be accomplished by connecting appropriate  $\overline{Q}$  outputs to the data input, as shown in the Function Selection table. Anti–lock gating is included in the MC14018B to assure proper counting sequence.



**Fully Static Operation** 

Schmitt Trigger on Clock Input

Capable of Driving Two Low-Power TTL Loads or One Low-Power

Schottky TTL Load Over the Rated Temperature Range

Pin-for-Pin Replacement for CD4018B

NLV Prefix for Automotive and Other Applications Requiring

Unique Site and Control Change Requirements; AEC-Q100

Qualified and PPAP Capable

This Device is Pb-Free and is RoHS Compliant

### MAXIMUM RATINGS (Voltages Referenced to VSS)

Symbol	Parameter	Value	Unit
$V_{DD}$	DC Supply Voltage Range	-0.5 to +18.0	V
V <sub>in</sub> , V <sub>out</sub>	Input or Output Voltage Range (DC or Transient)	-0.5 to V <sub>DD</sub> + 0.5	٧
I <sub>in</sub> , I <sub>out</sub>	Input or Output Current (DC or Transient) per Pin	10	mA
P <sub>D</sub>	Power Dissipation, per Package (Note 1)	500	mW
T <sub>A</sub>	Ambient Temperature Range	-55 to +125	•C
T <sub>stg</sub>	Storage Temperature Range	-65 to +150	•C
T <sub>L</sub>	Lead Temperature (8–Second Soldering)	260	•C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: "D/DW" Packages: -7.0 mW/°C From 65°C To 125°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either  $V_{SS}$  or  $V_{DD}$ ). Unused outputs must be left open.





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SOIC-16 D SUFFIX CASE 751B

#### **MARKING DIAGRAM**

14018BG AWLYWW

A Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G = Pb-Free Indicator

#### ORDERING INFORMATION

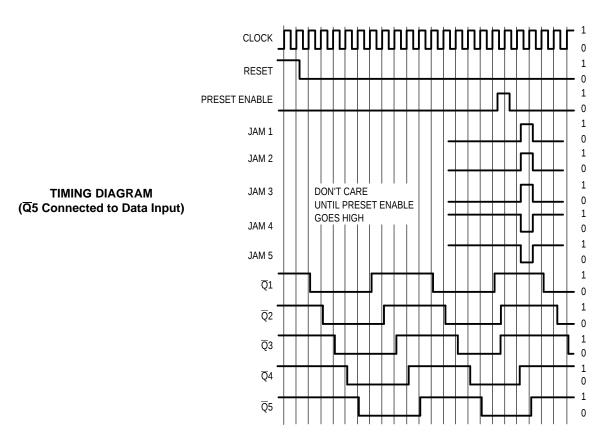
See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

## $\textbf{ELECTRICAL CHARACTERISTICS} \ (\text{Voltages Referenced to V}_{SS})$

				-55	5°C		25°C		125	5°C	
Characteristic		Symbol	V <sub>DD</sub> Vdc	Min	Max	Min	Typ (Note 2)	Max	Min	Max	Unit
Output Voltage V <sub>in</sub> = V <sub>DD</sub> or 0	"0" Level	V <sub>OL</sub>	5.0 10 15	- - -	0.05 0.05 0.05	- - -	0 0 0	0.05 0.05 0.05	- - -	0.05 0.05 0.05	Vdc
$V_{in} = 0$ or $V_{DD}$	"1" Level	V <sub>OH</sub>	5.0 10 15	4.95 9.95 14.95	- - -	4.95 9.95 14.95	5.0 10 15	- - -	4.95 9.95 14.95	- - -	Vdc
Input Voltage $(V_O = 4.5 \text{ or } 0.5 \text{ Vdc})$ $(V_O = 9.0 \text{ or } 1.0 \text{ Vdc})$ $(V_O = 13.5 \text{ or } 1.5 \text{ Vdc})$	"0" Level	V <sub>IL</sub>	5.0 10 15	- - -	1.5 3.0 4.0	- - -	2.25 4.50 6.75	1.5 3.0 4.0	- - -	1.5 3.0 4.0	Vdc
$(V_O = 0.5 \text{ or } 4.5 \text{ Vdc})$ $(V_O = 1.0 \text{ or } 9.0 \text{ Vdc})$ $(V_O = 1.5 \text{ or } 13.5 \text{ Vdc})$	"1" Level	V <sub>IH</sub>	5.0 10 15	3.5 7.0 11	- - -	3.5 7.0 11	2.75 5.50 8.25	- - -	3.5 7.0 11	- - -	Vdc
Output Drive Current $ (V_{OH} = 2.5 \text{ Vdc}) $ $ (V_{OH} = 4.6 \text{ Vdc}) $ $ (V_{OH} = 9.5 \text{ Vdc}) $ $ (V_{OH} = 13.5 \text{ Vdc}) $	Source	I <sub>OH</sub>	5.0 5.0 10 15	-3.0 -0.64 -1.6 -4.2	- - -	-2.4 -0.51 -1.3 -3.4	-4.2 -0.88 -2.25 -8.8	- - - -	-1.7 -0.36 -0.9 -2.4	- - - -	mAdc
$(V_{OL} = 0.4 \text{ Vdc})$ $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$	Sink	I <sub>OL</sub>	5.0 10 15	0.64 1.6 4.2	- - -	0.51 1.3 3.4	0.88 2.25 8.8	- - -	0.36 0.9 2.4	- - -	mAdc
Input Current		I <sub>in</sub>	15	-	0.1 Tr	n(–)TjET2	2698531.72(d	efBT8 0 0	8 284.144	9 f303.76	61 475.99

**SWITCHING CHARACTERISTICS** (Note 5) ( $C_L = 50 \text{ pF}, T_A = 25^{\circ}C$ )

			All Types	
		$V_{DD}$	Тур	
Characteristic	Symbol	Vdc	Min	Unit



#### **FUNCTION SELECTION**

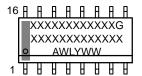
Counter Mode	Connect Data Input (Pin 1) to:	Comments						
Divide by 10 Divide by 8 Divide by 6 Divide by 4 Divide by 2	Q5 Q4 Q3 Q2 Q1	No external components needed.			LO	GIC DIAGF	RAM	
Divide by 9 Divide by 7 Divide by 5 Divide by 3	Q5 Q4 Q4 Q3 Q3 Q2 Q2 Q1	Gate package needed to provide AND function. Counter Skips all 1's state		JAM 1	JAM 2	JAM 3	JAM 4	JAM 5
			CLOCK SHAPER	D S Q C R P	D S Q C Q R P	D S Q C R P	D S Q C R P	D S Q C R P
		NABLE 1 10 0	V <sub>DD</sub> = PIN 16 V <sub>SS</sub> = PIN 8	5	7	7 \( \sigma \)	11	13
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### SOIC-16 9.90x3.90x1.50 1.27P CASE 751B ISSUE L

## **SOIC-16 9.90x3.90x1.50 1.27P**CASE 751B ISSUE L

**DATE 29 MAY 2024** 

## GENERIC MARKING DIAGRAM\*

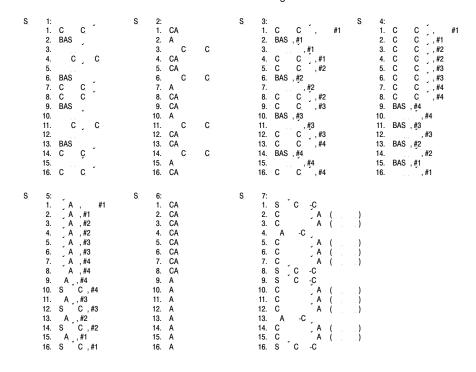


XXXXX = Specific Device Code

A = Assembly Location

WL = Wafer Lot
 Y = Year
 WW = Work Week
 G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



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